



UF740

Power MOSFET

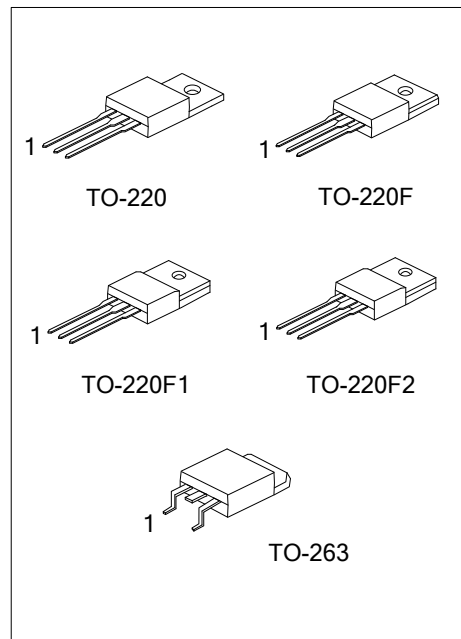
10A, 400V, 0.55Ω N-CHANNEL POWER MOSFET

DESCRIPTION

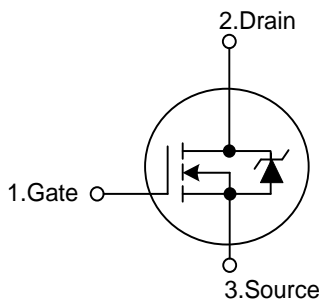
The N-Channel enhancement mode silicon gate power MOSFET is designed for high voltage, high speed power switching applications such as switching regulators, switching converters, solenoid, motor drivers, relay drivers.

FEATURES

- * 10A, 400V, $R_{DS(ON)}$ (0.55Ω)
- * Single Pulse Avalanche Energy Rated
- * Rugged - SOA is Power Dissipation Limited
- * Fast Switching Speeds
- * Linear Transfer Characteristics
- * High Input Impedance



SYMBOL



ORDERING INFORMATION

| Ordering Number | | Package | Pin Assignment | | | Packing |
|-----------------|--------------|----------|----------------|---|---|-----------|
| Lead Free | Halogen Free | | 1 | 2 | 3 | |
| UF740L-TA3-T | UF740G-TA3-T | TO-220 | G | D | S | Tube |
| UF740L-TF1-T | UF740G-TF1-T | TO-220F1 | G | D | S | Tube |
| UF740L-TF2-T | UF740G-TF2-T | TO-220F2 | G | D | S | Tube |
| UF740L-TF3-T | UF740G-TF3-T | TO-220F | G | D | S | Tube |
| UF740L-TQ2-T | UF740G-TQ2-T | TO-263 | G | D | S | Tube |
| UF740L-TQ2-R | UF740G-TQ2-R | TO-263 | G | D | S | Tape Reel |

Note: Pin Assignment: G: Gate D: Drain S: Source

| | |
|---|---|
| <p>UF740L-TA3-T</p> <p>(1)Packing Type (2)Package Type (3)Lead Free</p> | <p>(1) R: Tape Reel, T: Tube (2) TA3: TO-220, TF1: TO-220F1, TF2: TO-220F2, TF3: TO-220F, TQ2: TO-263 (3) L: Lead Free, G: Halogen Free</p> |
|---|---|

■ ABSOLUTE MAXIMUM RATINGS ($T_C = 25^\circ\text{C}$, Unless Otherwise Specified)

| PARAMETER | | SYMBOL | RATINGS | UNIT |
|---|---------------------------|-----------|------------|---------------------|
| Drain to Source Voltage ($T_J = 25^\circ\text{C} \sim 125^\circ\text{C}$) | | V_{DS} | 400 | V |
| Drain to Gate Voltage ($R_{GS} = 20\text{k}\Omega$) ($T_J = 25^\circ\text{C} \sim 125^\circ\text{C}$) | | V_{DGR} | 400 | V |
| Gate to Source Voltage | | V_{GS} | ± 20 | V |
| Drain Current | Continuous | I_D | 10 | A |
| | $T_C = 100^\circ\text{C}$ | I_D | 6.3 | A |
| | Pulsed | I_{DM} | 40 | A |
| Avalanche Energy | Single Pulsed (Note 3) | E_{AS} | 520 | mJ |
| Power Dissipation | TO-220/TO-263 | P_D | 125 | W |
| | TO-220F/TO-220F1 | | 44 | |
| | TO-220F2 | | 46 | |
| Derating above 25°C | TO-220/TO-263 | | 1.0 | W/ $^\circ\text{C}$ |
| | TO-220F/TO-220F1 | | 0.35 | |
| | TO-220F2 | | 0.37 | |
| Junction Temperature | | T_J | +150 | $^\circ\text{C}$ |
| Operating Temperature | | T_{OPR} | -55 ~ +150 | $^\circ\text{C}$ |
| Storage Temperature | | T_{STG} | -55 ~ +150 | $^\circ\text{C}$ |

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

■ THERMAL DATA

| PARAMETER | | SYMBOL | RATINGS | UNIT |
|---------------------|------------------|---------------|---------|---------------------------|
| Junction to Ambient | | θ_{JA} | 62.5 | $^\circ\text{C}/\text{W}$ |
| Junction to Case | TO-220/TO-263 | θ_{Jc} | 1.0 | $^\circ\text{C}/\text{W}$ |
| | TO-220F/TO-220F1 | | 2.86 | |
| | TO-220F2 | | 2.72 | |

■ ELECTRICAL CHARACTERISTICS (T_C = 25°C, Unless Otherwise Specified.)

| PARAMETER | SYMBOL | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|--|-----------------------|---|---|------|------|------|
| Drain to Source Breakdown Voltage | BV _{DSS} | V _{GS} = 0V, I _D = 250μA | 400 | | | V |
| Gate to Threshold Voltage | V _{GS(THR)} | V _{GS} = V _{DS} , I _D = 250μA | 2.0 | | 4.0 | V |
| On-State Drain Current (Note 1) | I _{D(ON)} | V _{DS} > I _{D(ON)} × R _{DS(ON)MAX} , V _{GS} = 10V | 10 | | | A |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = Rated BV _{DSS} , V _{GS} = 0V | | | 25 | μA |
| | | V _{DS} = 0.8 × Rated BV _{DSS} , V _{GS} = 0V, T _J = 125°C | | | 250 | μA |
| Gate to Source Leakage Current | I _{GSS} | V _{GS} = ±20V | | | ±500 | nA |
| Drain to Source On Resistance | R _{DS(ON)} | V _{GS} = 10V, I _D = 5.2A (Note 1) | | 0.38 | 0.55 | Ω |
| Forward Transconductance | g _{FS} | V _{DS} ≥ 50V, I _D = 5.2A (Note 1) | 5.8 | 8.9 | | S |
| Turn-On Delay Time | t _{DLY(ON)} | V _{DD} = 200V, I _D ≈ 10A, | | 65 | 75 | ns |
| Rise Time | t _R | R _{GS} = 9.1Ω, R _L = 20Ω, V _{GS} = 10V | | 130 | 145 | ns |
| Turn-Off Delay Time | t _{DLY(OFF)} | MOSFET Switching Times are Essentially Independent of Operating Temperature | | 240 | 260 | ns |
| Fall Time | t _F | | | 145 | 155 | ns |
| Total Gate Charge (Gate to Source + Gate to Drain) | Q _{G(TOT)} | V _{GS} = 10V, I _D = 10A, I _{G(REF)} = 1.5mA, V _{DS} = 0.8 × Rated BV _{DSS} | | 138 | | nC |
| Gate to Source Charge | Q _{GS} | Gate Charge is Essentially Independent of Operating Temperature | | 35 | | nC |
| Gate to Drain "Miller" Charge | Q _{GD} | | | 35 | | nC |
| Input Capacitance | C _{ISS} | | | 1170 | | pF |
| Output Capacitance | C _{OSS} | V _{GS} = 0V, V _{DS} = 25V, f = 1.0MHz | | 160 | | pF |
| Reverse - Transfer Capacitance | C _{RSS} | | | 26 | | pF |
| Internal Drain Inductance | L _D | Measured From the Contact Screw on Tab to Center of Die | Modified MOSFET Symbol Showing the Internal Devices Inductances | | 3.5 | nH |
| | | Measured From the Drain Lead, 6mm (0.25in) From Package to Center of Die | | | 4.5 | nH |
| Internal Source Inductance | L _S | Measured From the Source Lead, 6mm (0.25in) From Header to Source Bonding Pad | | | 7.5 | nH |

SOURCE TO DRAIN DIODE SPECIFICATIONS

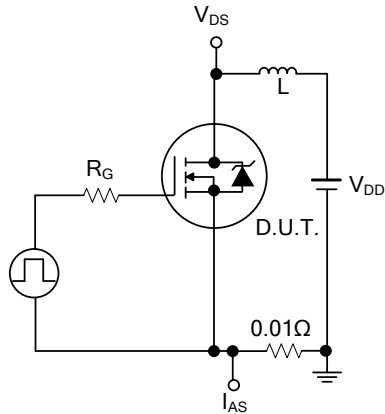
| | | | | | | |
|--|-----------------|--|-----|-----|-----|----|
| Source to Drain Diode Voltage | V _{SD} | T _J = 25°C, I _{SD} = 10A, V _{GS} = 0V (Note 1) | | | 2.0 | V |
| Continuous Source to Drain Current | I _S | Modified MOSFET Symbol Showing the Integral Reverse P-N Junction Diode | | | 10 | A |
| Pulse Source to Drain Current (Note 2) | I _{SM} | | | | 40 | A |
| Reverse Recovery Time | t _{rr} | T _J = 25°C, I _{SD} = 10A, dI _{SD} /dt = 100A/μs | 170 | 390 | 790 | ns |
| Reverse Recovery Charge | Q _{RR} | T _J = 25°C, I _{SD} = 10A, dI _{SD} /dt = 100A/μs | 1.6 | 4.5 | 8.2 | μC |

Notes: 1. Pulse Test: Pulse width ≤ 300μs, Duty Cycle ≤ 2%.

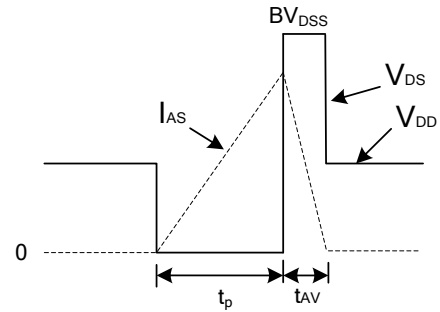
2. Repetitive rating: Pulse width limited by maximum junction temperature.

3. V_{DD} = 50V, starting T_J = 25°C, L = 9.1mH, R_G = 25Ω, peak I_{AS} = 10A

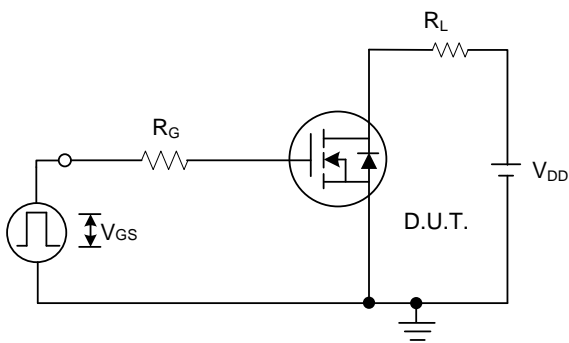
■ TEST CIRCUITS AND WAVEFORMS



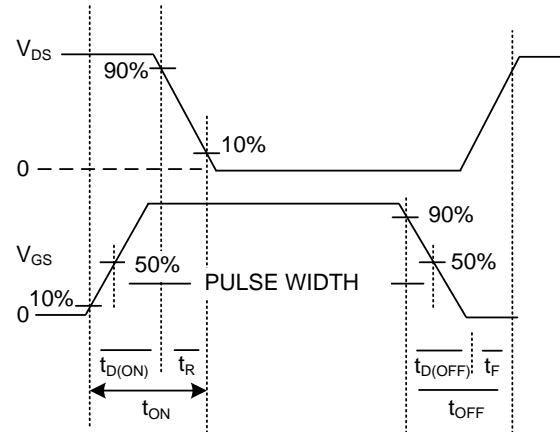
Unclamped Energy Test Circuit



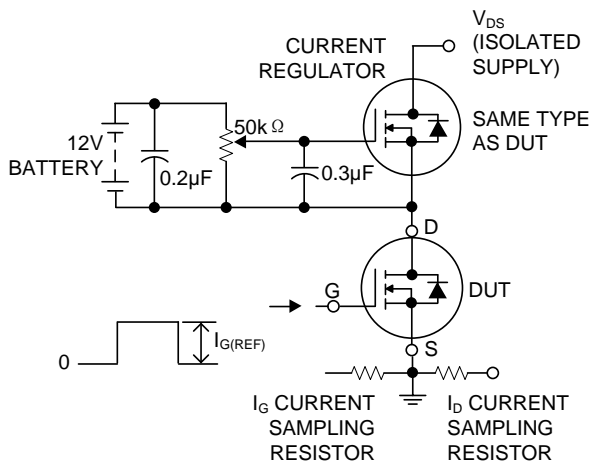
Unclamped Energy Waveforms



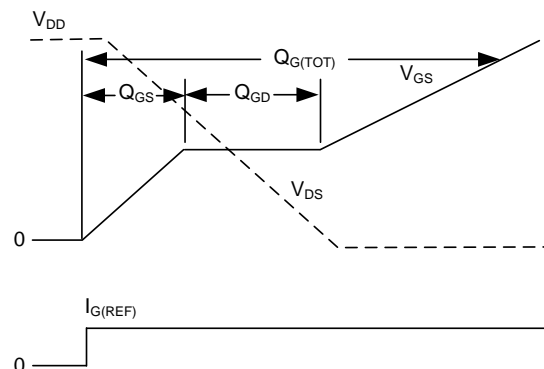
Switching Time Test Circuit



Resistive Switching Waveforms



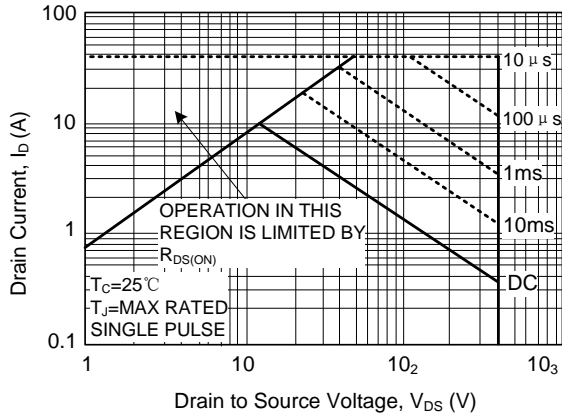
Gate Charge Test Circuit



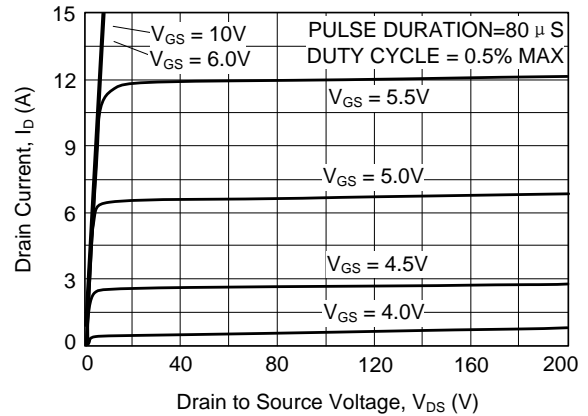
Gate Charge Waveforms

TYPICAL PERFORMANCE CURVES

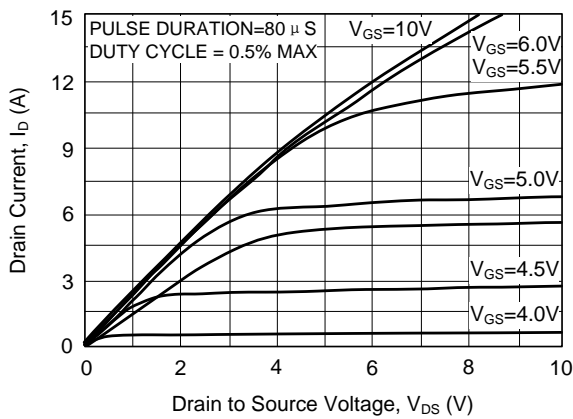
Forward Bias Safe Operating Area



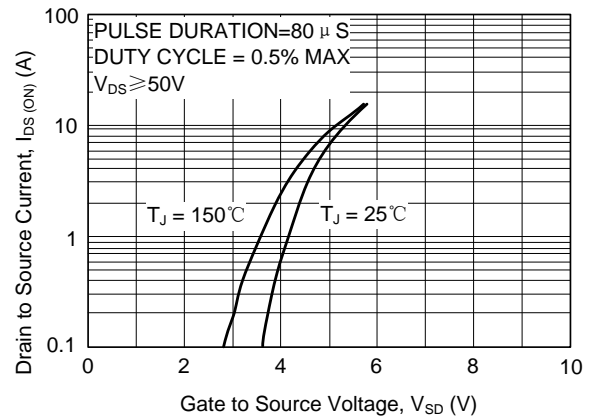
Output Characteristics



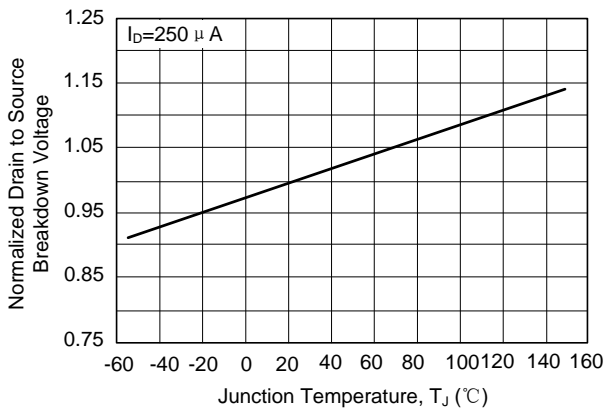
Saturation Characteristics



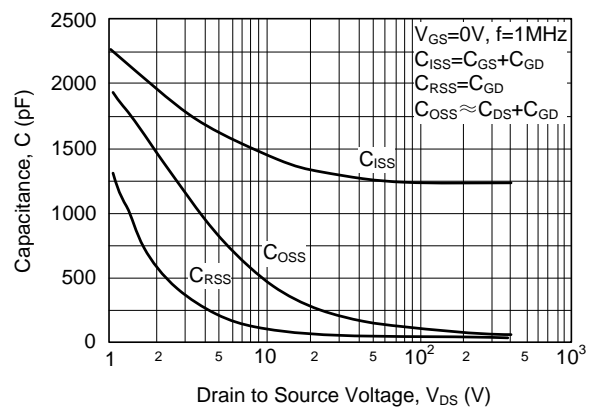
Transfer Characteristics



Normalized Drain to Source Breakdown Voltage vs. Junction Temperature

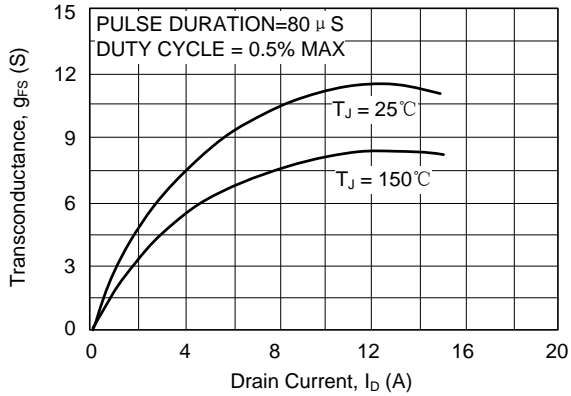


Capacitance vs. Drain to Source Voltage

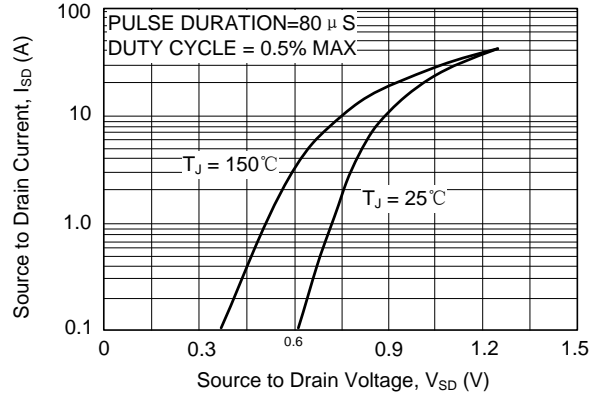


TYPICAL PERFORMANCE CUVES (Cont.)

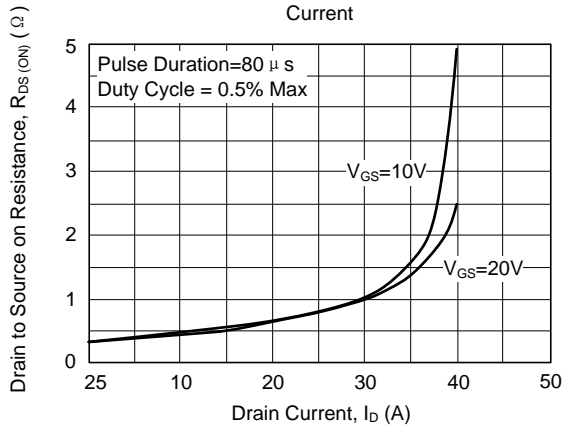
Transconduce vs. Drain Current



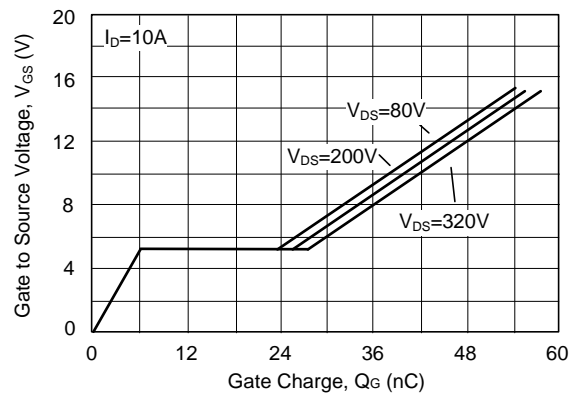
Source to Drain Diode Voltage



Drain to Source on Resistance vs. Voltage and Drain Current



Gate to Source Voltage vs. Gate Charge



UTC assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all UTC products described or contained herein. UTC products are not designed for use in life support appliances, devices or systems where malfunction of these products can be reasonably expected to result in personal injury. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner. The information presented in this document does not form part of any quotation or contract, is believed to be accurate and reliable and may be changed without notice.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for [MOSFET](#) category:

Click to view products by [Unisonic](#) manufacturer:

Other Similar products are found below :

[614233C](#) [648584F](#) [FDPF9N50NZ](#) [IRFD120](#) [IRFF430](#) [JANTX2N5237](#) [2N7000](#) [FCA20N60_F109](#) [FDZ595PZ](#) [2SK2267\(Q\)](#) [2SK2545\(Q,T\)](#)
[405094E](#) [423220D](#) [MIC4420CM-TR](#) [VN1206L](#) [614234A](#) [715780A](#) [SSM6J414TU,LF\(T](#) [751625C](#) [PSMN4R2-30MLD](#)
[TK31J60W5,S1VQ\(O](#) [2SK2614\(TE16L1,Q\)](#) [DMN1017UCP3-7](#) [EFC2J004NUZTDG](#) [FCAB21350L1](#) [P85W28HP2F-7071](#) [DMN1053UCP4-7](#)
[NTE2384](#) [NTE2969](#) [NTE6400A](#) [DMN61D9UWQ-13](#) [US6M2GTR](#) [DMN31D5UDJ-7](#) [SSM6P54TU,LF](#) [DMP22D4UFO-7B](#)
[IPS60R3K4CEAKMA1](#) [DMN1006UCA6-7](#) [DMN16M9UCA6-7](#) [STF5N65M6](#) [STU5N65M6](#) [C3M0021120D](#) [DMN13M9UCA6-7](#)
[BSS340NWH6327XTSA1](#) [MCM3400A-TP](#) [DMTH10H4M6SPS-13](#) [IPS60R1K0PFD7SAKMA1](#) [IPS60R360PFD7SAKMA1](#)
[IPS60R600PFD7SAKMA1](#) [IPS60R210PFD7SAKMA1](#) [DMN2990UFB-7B](#)